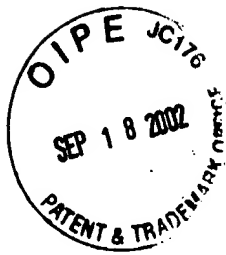


September 5, 2002



To: Commissioner of Patents and Trademarks  
Washington, D.C. 20231  
ATTN: Group Art Unit 2815 J. R. Diaz  
From: Stephen B. Ackerman, Reg. No. 37,761  
20 McIntosh Drive  
Poughkeepsie, N. Y. 12603

#8  
9/25/02  
RECEIVED  
SEP 20 2002  
TECHNOLOGY CENTER 2800

| Serial No. 09/764,242 01/19/2001 |

Wong

A FILL PATTERN IN KERF AREAS TO PREVENT LOCALIZED  
NON-UNIFORMITIES OF INSULATING LAYERS AT DIE  
CORNERS ON SEMICONDUCTOR SUBSTRATES

| Group Art Unit: 2815 J. R. Diaz |

## RESPONSE TO PATENT OFFICE ACTION

Dear Sir or Madam:

The Commissioner is hereby authorized to charge payment of  
any additional fees involved with added Claims and the like  
to Deposit Account No. 19-0033.

In response to Office Action dated June 13, 2002, please  
consider the following remarks.

## CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited  
with the U. S. Postal Service as first class mail in an  
envelope addressed to: Commissioner of Patents and  
Trademarks, Washington, D.C. 20231, on Sept. 13, 2002.

Stephen B. Ackerman, Reg. No. 37,761

Signature 

Date

9/13/02